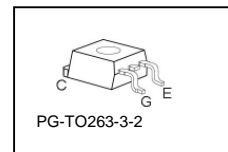
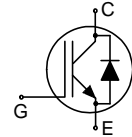


## HighSpeed 2-Technology with soft, fast recovery anti-parallel Emitter Controlled HE diode

- Designed for frequency inverters for washing machines, fans, pumps and vacuum cleaners
- 2<sup>nd</sup> generation HighSpeed-Technology for 1200V applications offers:**
  - loss reduction in resonant circuits
  - temperature stable behavior
  - parallel switching capability
  - tight parameter distribution
  - $E_{off}$  optimized for  $I_C = 3A$
- Qualified according to JEDEC<sup>2</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



Type	$V_{CE}$	$I_C$	$E_{off}$	$T_j$	Marking	Package
IKB03N120H2	1200V	3A	0.15mJ	150°C	K03H1202	PG-TO263-3-2

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CE}$	1200	V
Triangular collector current	$I_C$		A
$T_C = 25^\circ\text{C}$ , $f = 140\text{kHz}$		9.6	
$T_C = 100^\circ\text{C}$ , $f = 140\text{kHz}$		3.9	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	$I_{Cpuls}$	9.9	
Turn off safe operating area $V_{CE} \leq 1200\text{V}$ , $T_j \leq 150^\circ\text{C}$	-	9.9	
Diode forward current	$I_F$		
$T_C = 25^\circ\text{C}$		9.6	
$T_C = 100^\circ\text{C}$		3.9	
Gate-emitter voltage	$V_{GE}$	$\pm 20$	V
Power dissipation $T_C = 25^\circ\text{C}$	$P_{tot}$	62.5	W
Operating junction and storage temperature	$T_j, T_{stg}$	-40...+150	°C
Soldering temperature (reflow soldering, MSL1)	-	260	

<sup>2</sup> J-STD-020 and JESD-022

**Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction – case	$R_{thJC}$		2.0	K/W
Diode thermal resistance, junction - case	$R_{thJCD}$		3.2	
Thermal resistance, junction – ambient <sup>1)</sup>	$R_{thJA}$		40	

**Electrical Characteristic, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
<b>Static Characteristic</b>						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=300\mu A$	1200	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C=3A$ $T_j=25^\circ\text{C}$	-	2.2	2.8	
		$T_j=150^\circ\text{C}$ $V_{GE} = 10V, I_C=3A,$ $T_j=25^\circ\text{C}$	-	2.5	-	
Diode forward voltage	$V_F$	$V_{GE} = 0, I_F=2A$ $T_j=25^\circ\text{C}$	-	2.0	2.5	
			$T_j=150^\circ\text{C}$	-	1.75	-
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=90\mu A, V_{CE}=V_{GE}$	2.1	3	3.9	
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V$ $T_j=25^\circ\text{C}$	-	-	20	$\mu A$
			$T_j=150^\circ\text{C}$	-	-	
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE}=20V, I_C=3A$	-	2	-	S
<b>Dynamic Characteristic</b>						
Input capacitance	$C_{iss}$	$V_{CE}=25V,$ $V_{GE}=0V,$ $f=1\text{MHz}$	-	205	-	pF
Output capacitance	$C_{oss}$		-	24	-	
Reverse transfer capacitance	$C_{riss}$		-	7	-	
Gate charge	$Q_{Gate}$	$V_{CC}=960V, I_C=3A$ $V_{GE}=15V$	-	22	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$		-	7	-	nH

<sup>1)</sup> Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70 $\mu$ m thick) copper area for collector connection. PCB is vertical without blown air.

**Switching Characteristic, Inductive Load, at  $T_j=25^\circ\text{C}$** 

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-on delay time	$t_{d(on)}$	$T_j=25^\circ\text{C}$ , $V_{CC}=800\text{V}$ , $I_C=3\text{A}$ , $V_{GE}=15\text{V}/0\text{V}$ , $R_G=82\Omega$ , $L_\sigma^{(2)}=180\text{nH}$ , $C_\sigma^{(2)}=40\text{pF}$ Energy losses include "tail" and diode <sup>4)</sup> reverse recovery.	-	9.2	-	ns
Rise time	$t_r$		-	5.2	-	
Turn-off delay time	$t_{d(off)}$		-	281	-	
Fall time	$t_f$		-	29	-	
Turn-on energy	$E_{on}$		-	0.14	-	mJ
Turn-off energy	$E_{off}$		-	0.15	-	
Total switching energy	$E_{ts}$		-	0.29	-	
<b>Anti-Parallel Diode Characteristic</b>						
Diode reverse recovery time	$t_{rr}$	$T_j=25^\circ\text{C}$ , $V_R=800\text{V}$ , $I_F=3\text{A}$ , $R_G=82\Omega$	-	42	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.23	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	10.3	-	A
Diode current slope	$di_F/dt$		-	993	-	$\text{A}/\mu\text{s}$
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	1180	-	

**Switching Characteristic, Inductive Load, at  $T_j=150^\circ\text{C}$** 

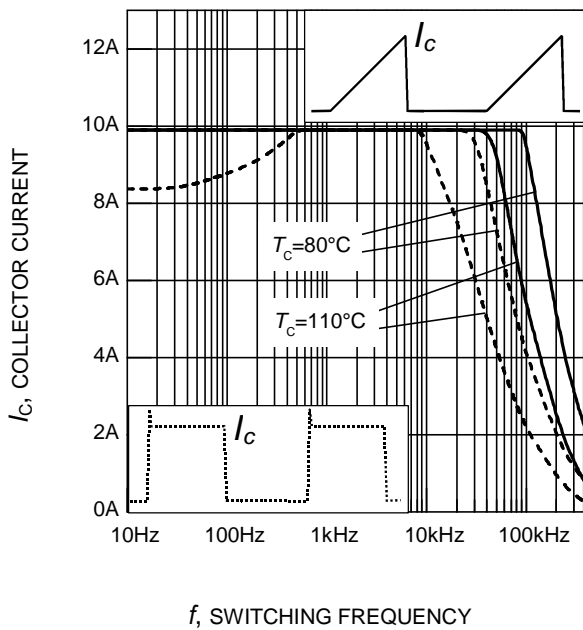
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-on delay time	$t_{d(on)}$	$T_j=150^\circ\text{C}$ $V_{CC}=800\text{V}$ , $I_C=3\text{A}$ , $V_{GE}=15\text{V}/0\text{V}$ , $R_G=82\Omega$ , $L_\sigma^{(2)}=180\text{nH}$ , $C_\sigma^{(2)}=40\text{pF}$ Energy losses include "tail" and diode <sup>3)</sup> reverse recovery.	-	9.4	-	ns
Rise time	$t_r$		-	6.7	-	
Turn-off delay time	$t_{d(off)}$		-	340	-	
Fall time	$t_f$		-	63	-	
Turn-on energy	$E_{on}$		-	0.22	-	mJ
Turn-off energy	$E_{off}$		-	0.26	-	
Total switching energy	$E_{ts}$		-	0.48	-	
<b>Anti-Parallel Diode Characteristic</b>						
Diode reverse recovery time	$t_{rr}$	$T_j=150^\circ\text{C}$ $V_R=800\text{V}$ , $I_F=3\text{A}$ , $R_G=82\Omega$	-	125	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.51	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	12	-	A
Diode current slope	$di_F/dt$		-	829	-	$\text{A}/\mu\text{s}$
Diode peak rate of fall of reverse recovery current during $t_b$	$di_{rr}/dt$		-	540	-	

<sup>2)</sup> Leakage inductance  $L_\sigma$  and stray capacity  $C_\sigma$  due to dynamic test circuit in figure E

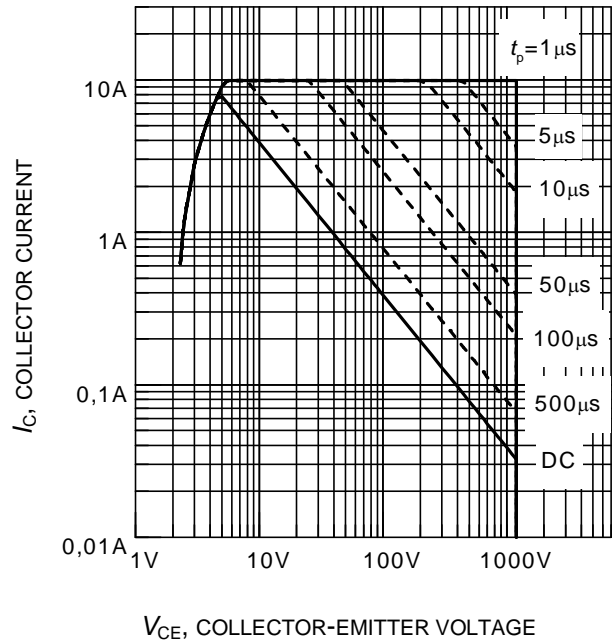
<sup>4)</sup> Commutation diode from device IKP03N120H2

**Switching Energy ZVT, Inductive Load**

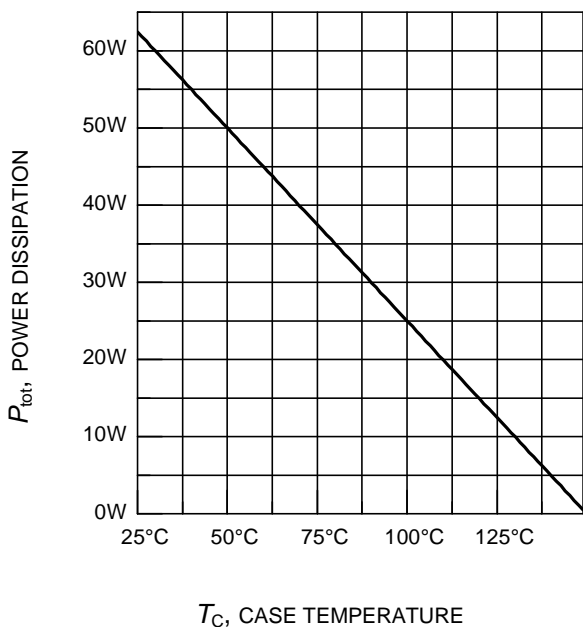
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-off energy	$E_{off}$	$V_{CC}=800V,$ $I_C=3A,$ $V_{GE}=15V/0V,$ $R_G=82\Omega,$ $C_r^{(2)}=4nF$ $T_j=25^\circ C$ $T_j=150^\circ C$	-	0.05	-	mJ
			-	0.09	-	



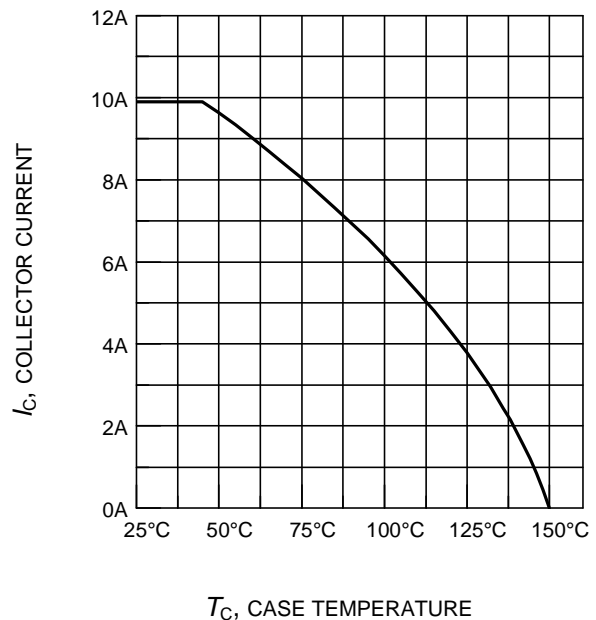
**Figure 1. Collector current as a function of switching frequency**  
 ( $T_j \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 82\Omega$ )



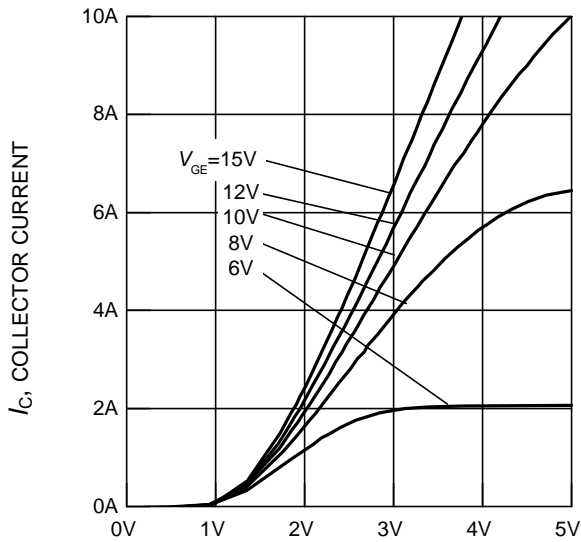
**Figure 2. Safe operating area**  
 ( $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$ )



**Figure 3. Power dissipation as a function of case temperature**  
 ( $T_j \leq 150^\circ\text{C}$ )

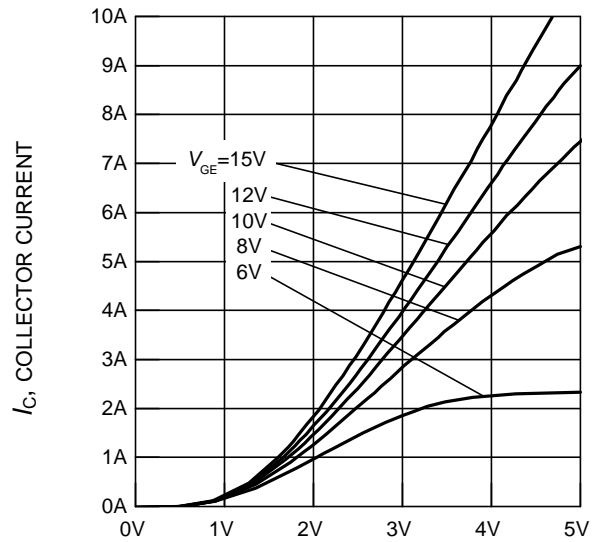


**Figure 4. Collector current as a function of case temperature**  
 ( $V_{GE} \leq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )



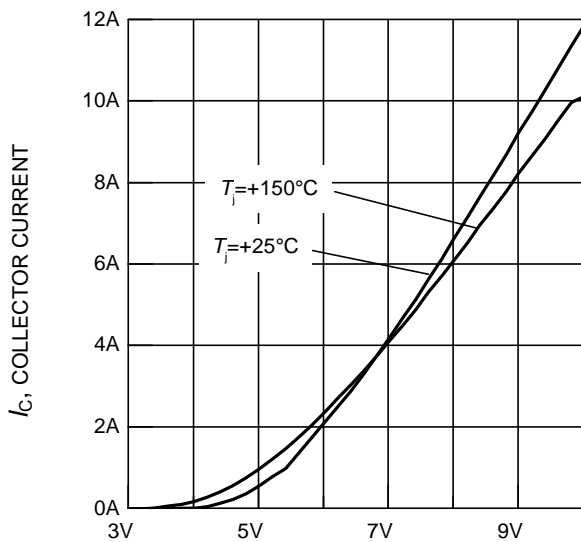
$V_{CE}$ , COLLECTOR-EMITTER VOLTAGE

**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



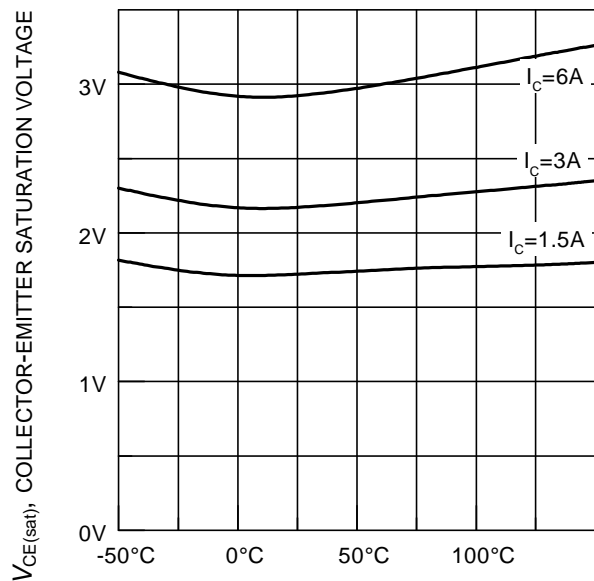
$V_{CE}$ , COLLECTOR-EMITTER VOLTAGE

**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



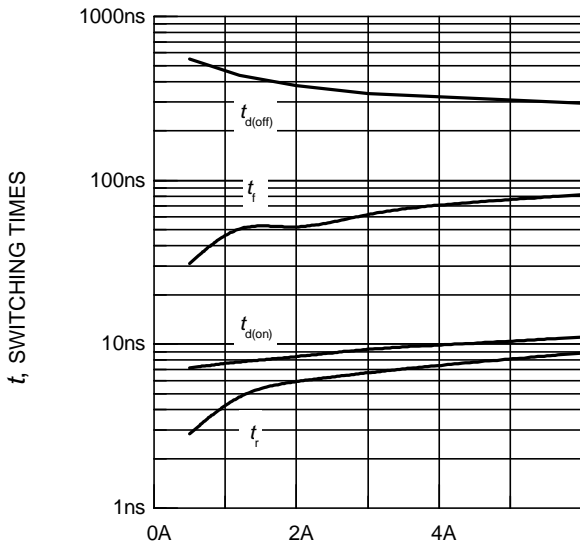
$V_{GE}$ , GATE-EMITTER VOLTAGE

**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 20\text{V}$ )



$T_j$ , JUNCTION TEMPERATURE

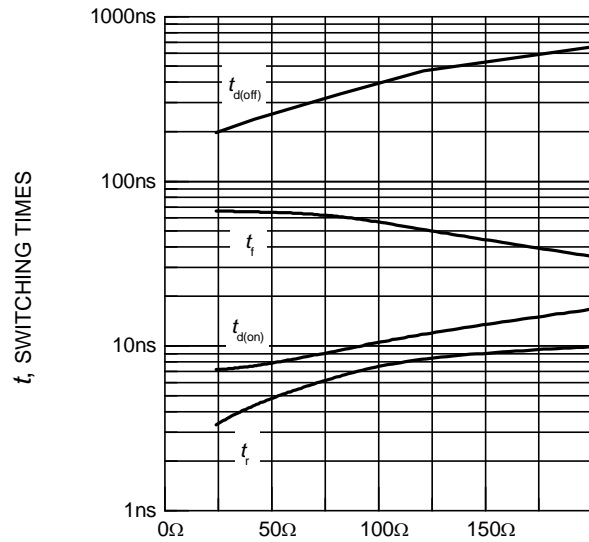
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



$I_C$ , COLLECTOR CURRENT

**Figure 9. Typical switching times as a function of collector current**

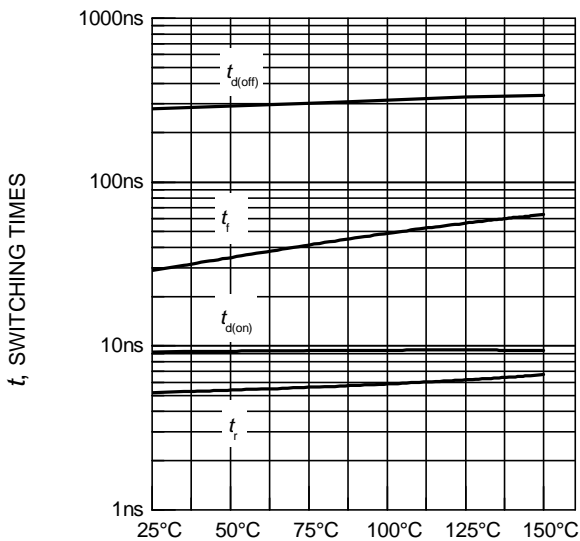
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 82\Omega$ , dynamic test circuit in Fig.E)



$R_G$ , GATE RESISTOR

**Figure 10. Typical switching times as a function of gate resistor**

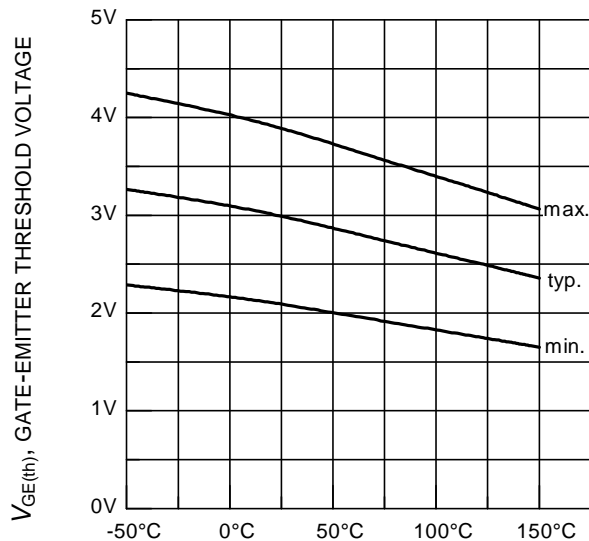
(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 3\text{A}$ , dynamic test circuit in Fig.E)



$T_j$ , JUNCTION TEMPERATURE

**Figure 11. Typical switching times as a function of junction temperature**

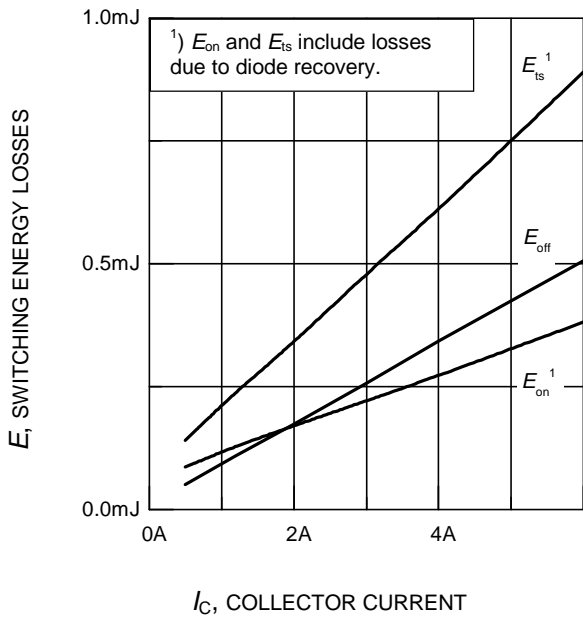
(inductive load,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 3\text{A}$ ,  $R_G = 82\Omega$ , dynamic test circuit in Fig.E)



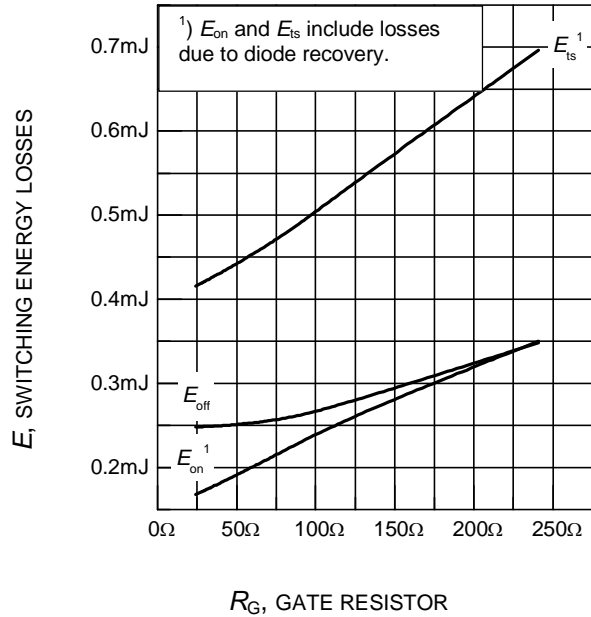
$T_j$ , JUNCTION TEMPERATURE

**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**

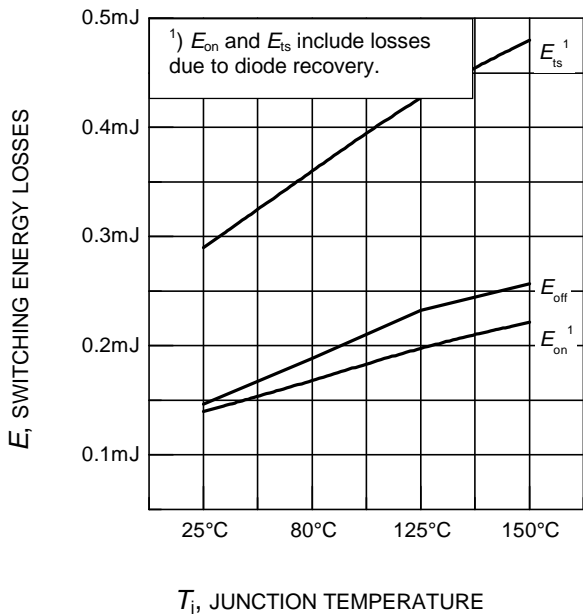
( $I_C = 0.09\text{mA}$ )



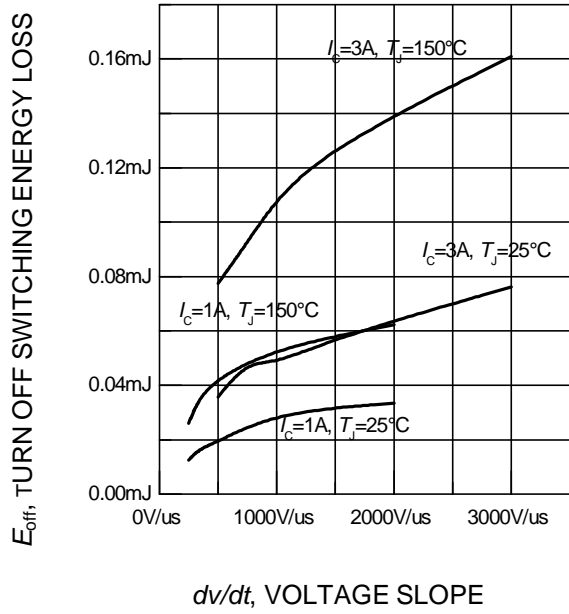
**Figure 13. Typical switching energy losses as a function of collector current**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $R_G = 82\Omega$ , dynamic test circuit in Fig.E )



**Figure 14. Typical switching energy losses as a function of gate resistor**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 3\text{A}$ , dynamic test circuit in Fig.E )

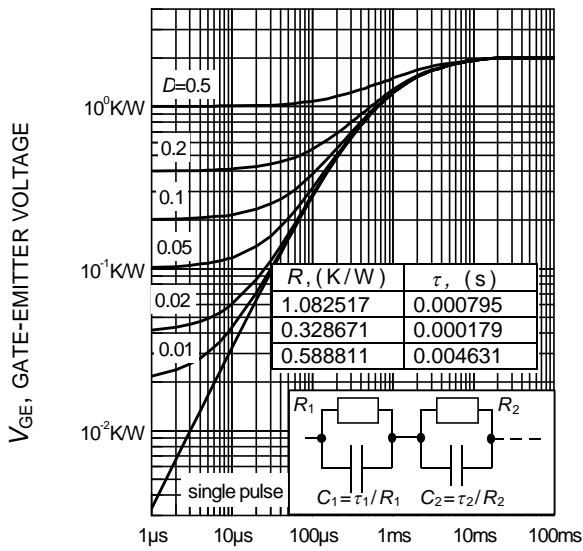


**Figure 15. Typical switching energy losses as a function of junction temperature**  
 (inductive load,  $V_{CE} = 800\text{V}$ ,  $V_{GE} = +15\text{V}/0\text{V}$ ,  $I_C = 3\text{A}$ ,  $R_G = 82\Omega$ , dynamic test circuit in Fig.E )

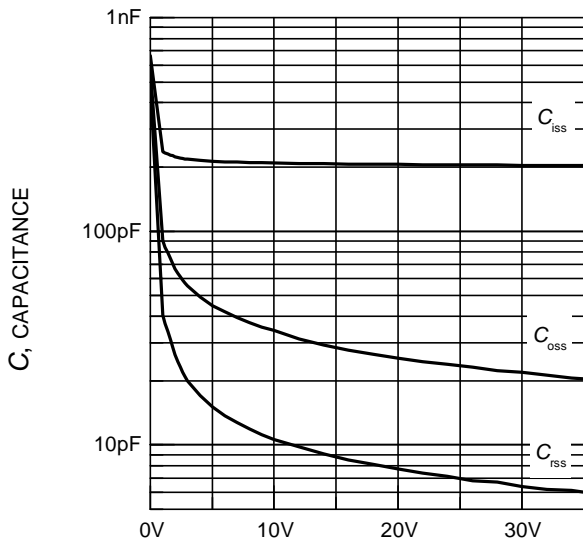


**Figure 16. Typical turn off switching energy loss for soft switching**  
 (dynamic test circuit in Fig. E)

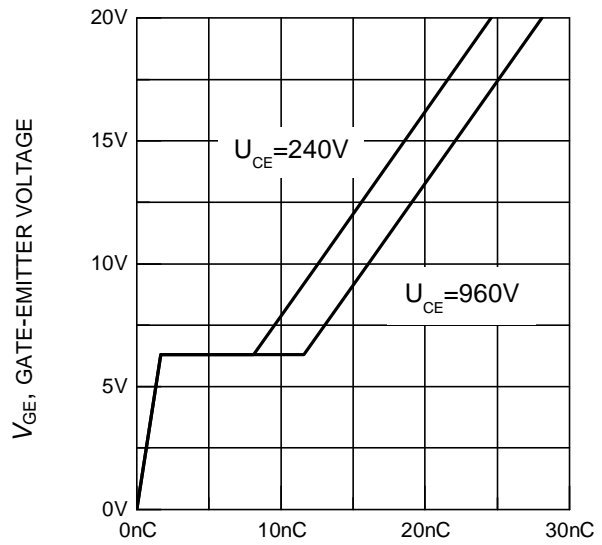




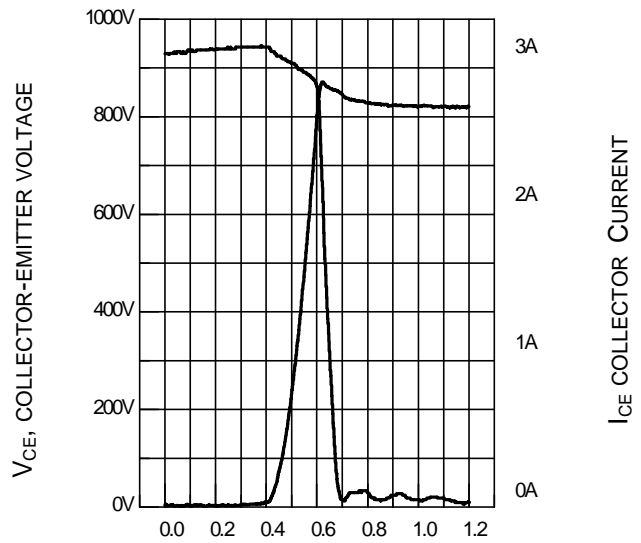
**Figure 17. Typical gate charge**  
( $I_C = 3A$ )



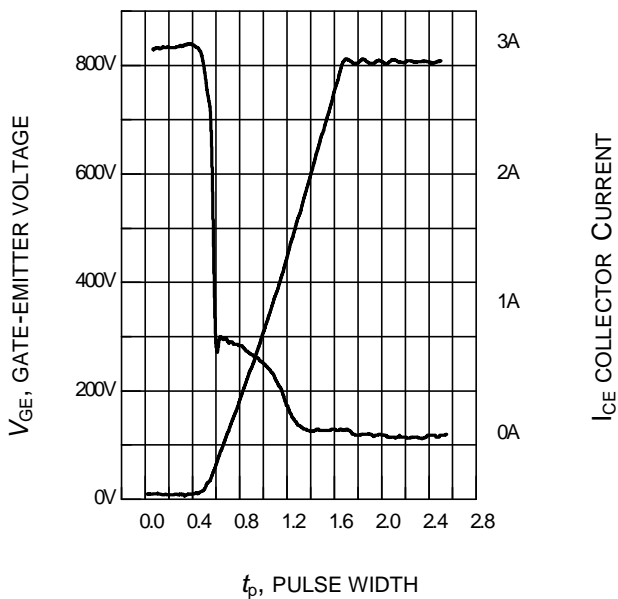
**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V$ ,  $f = 1MHz$ )



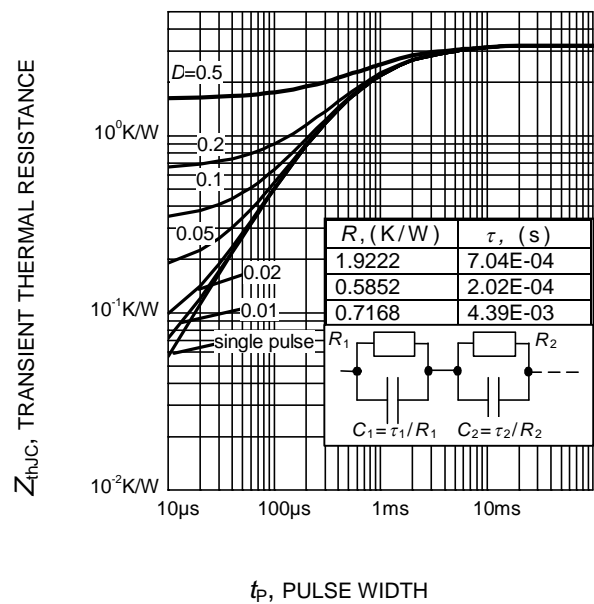
**Figure 19. Typical turn on behavior**  
( $I_C = 3A$ )



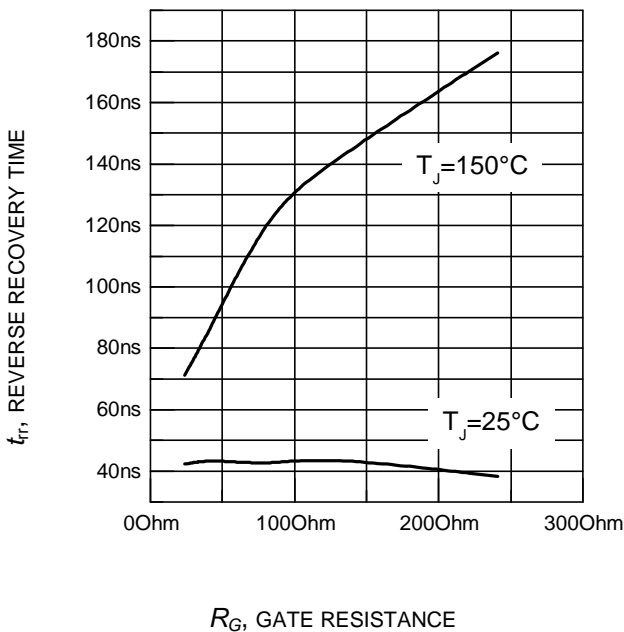
**Figure 20. Typical turn off behavior, hard switching**  
( $V_{GE} = 15/0V$ ,  $R_G = 82\Omega$ ,  $T_j = 150^\circ C$ ,  
Dynamic test circuit in Figure E)



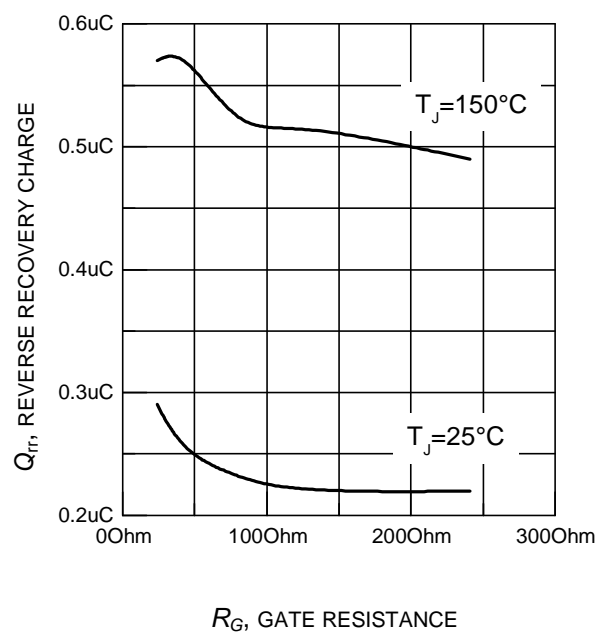
**Figure 21. Typical turn off behavior, soft switching**  
 ( $V_{GE}=15/0V$ ,  $R_G=82\Omega$ ,  $T_j = 150^\circ C$ ,  
 Dynamic test circuit in Figure E)



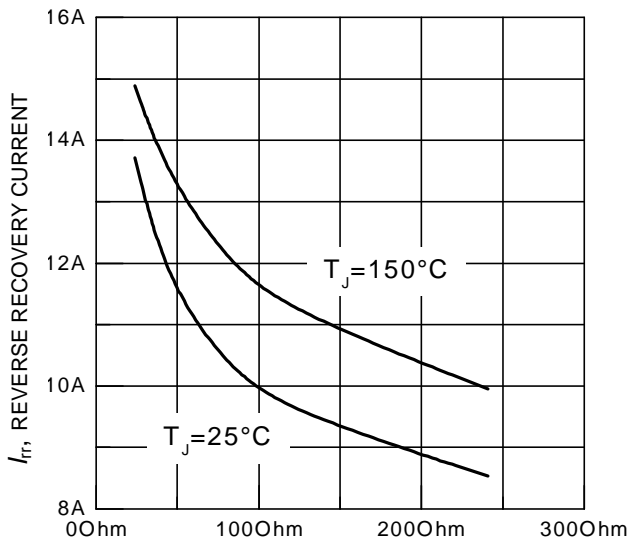
**Figure 22. Diode transient thermal impedance as a function of pulse width**  
 ( $D = t_p / T$ )



**Figure 23. Typical reverse recovery time as a function of diode current slope**  
 $V_R=800V$ ,  $I_F=3A$ ,  
 Dynamic test circuit in Figure E)

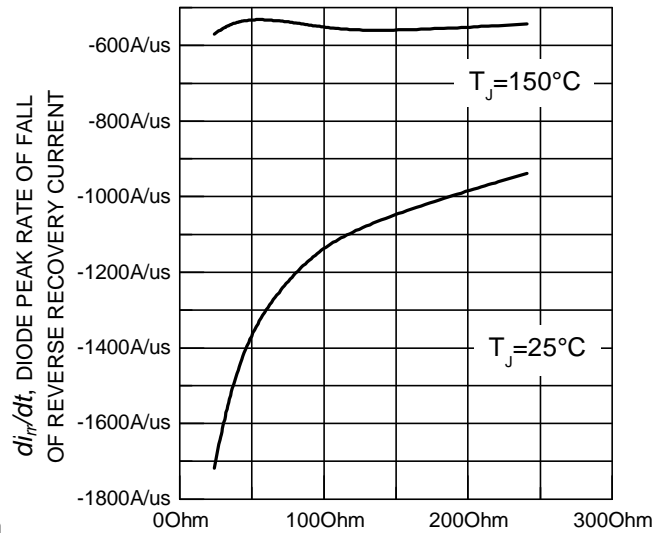


**Figure 24. Typical reverse recovery charge as a function of diode current slope**  
 $(V_R=800V$ ,  $I_F=3A$ ,  
 Dynamic test circuit in Figure E)



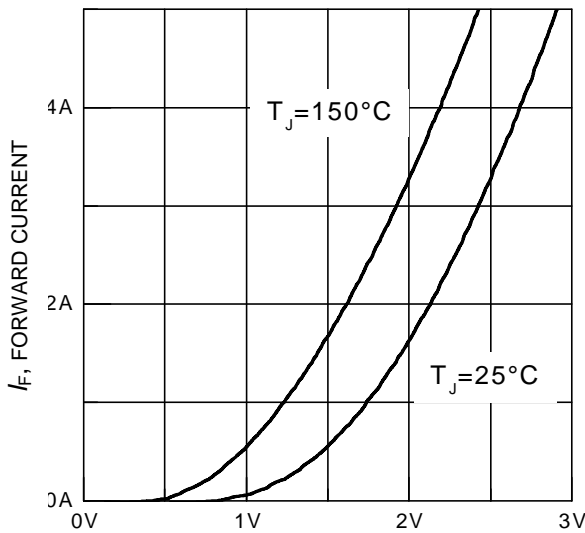
$R_G$ , GATE RESISTANCE

**Figure 25. Typical reverse recovery current as a function of diode current slope**  
 ( $V_R=800V$ ,  $I_F=3A$ ,  
 Dynamic test circuit in Figure E)



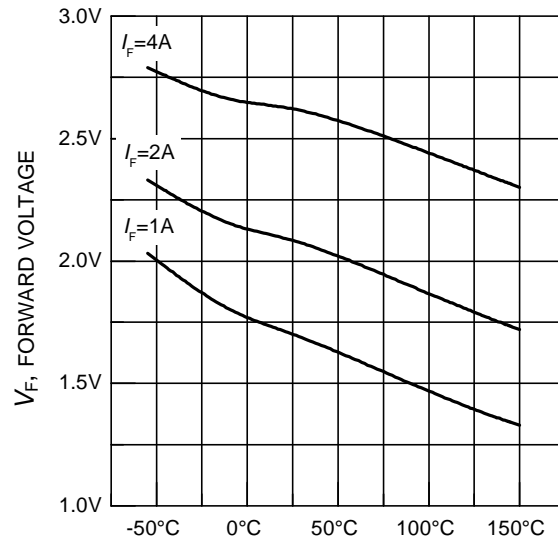
$R_G$ , GATE RESISTANCE

**Figure 26. Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**  
 ( $V_R=800V$ ,  $I_F=3A$ ,  
 Dynamic test circuit in Figure E)



$V_F$ , FORWARD VOLTAGE

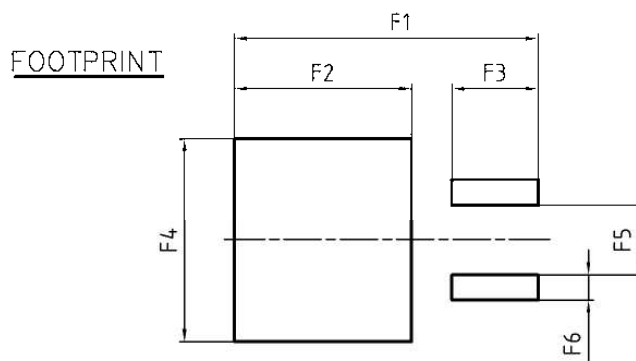
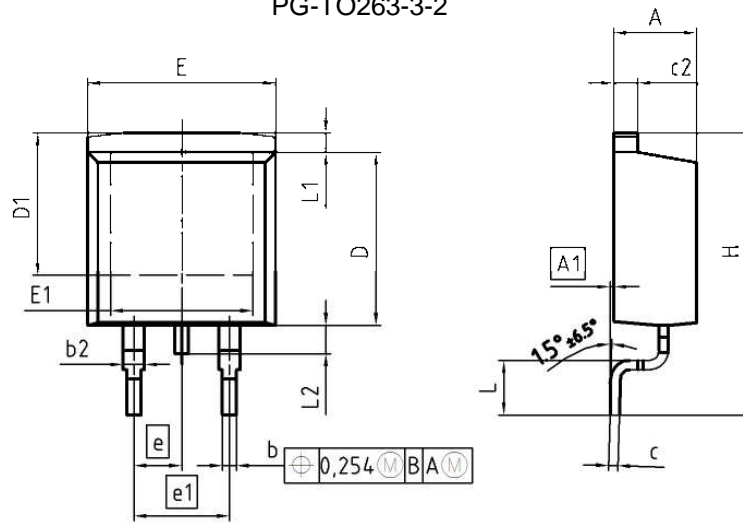
**Figure 27. Typical diode forward current as a function of forward voltage**



$T_J$ , JUNCTION TEMPERATURE

**Figure 28. Typical diode forward voltage as a function of junction temperature**

PG-TO263-3-2



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	0.00	0.25	0.000	0.010
b	0.65	0.85	0.026	0.033
b2	0.95	1.15	0.037	0.045
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.51	9.45	0.335	0.372
D1	7.10	7.90	0.280	0.311
E	9.80	10.31	0.386	0.406
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	2		2	
H	14.61	15.88	0.575	0.625
L	2.29	3.00	0.090	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
F1	16.05	16.25	0.632	0.640
F2	9.30	9.50	0.366	0.374
F3	4.50	4.70	0.177	0.185
F4	10.70	10.90	0.421	0.429
F5	3.65	3.85	0.144	0.152
F6	1.25	1.45	0.049	0.057

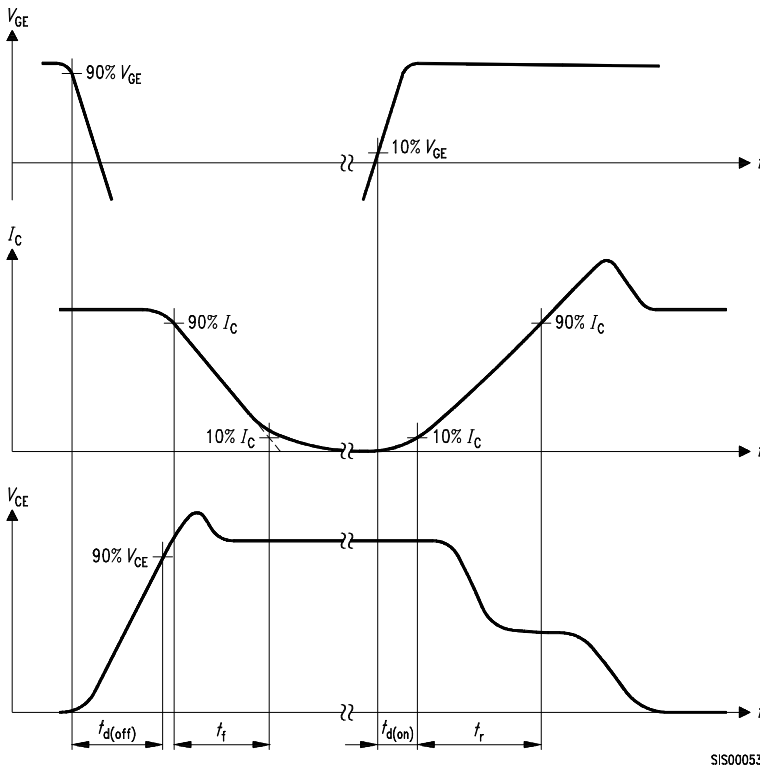
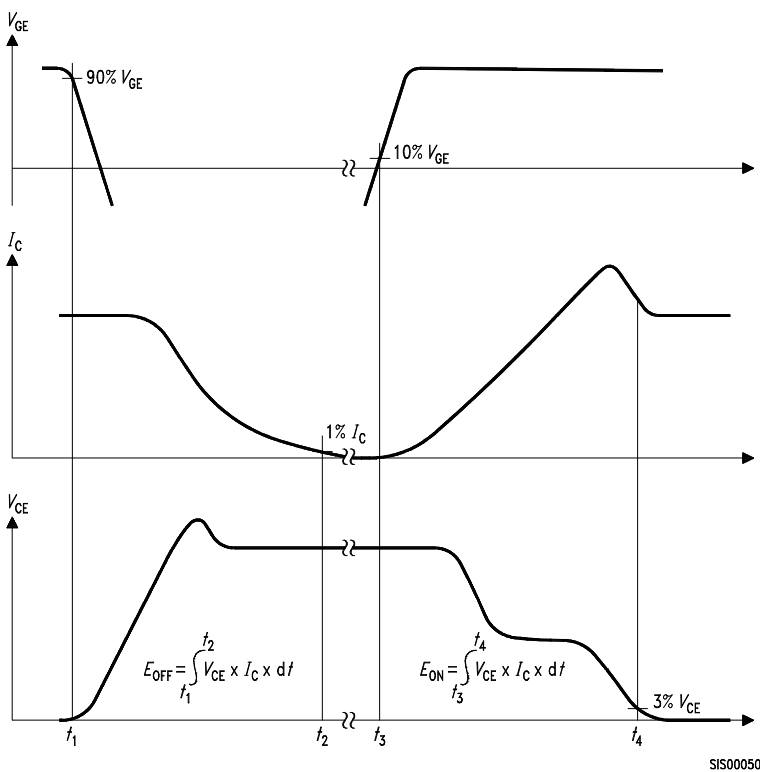
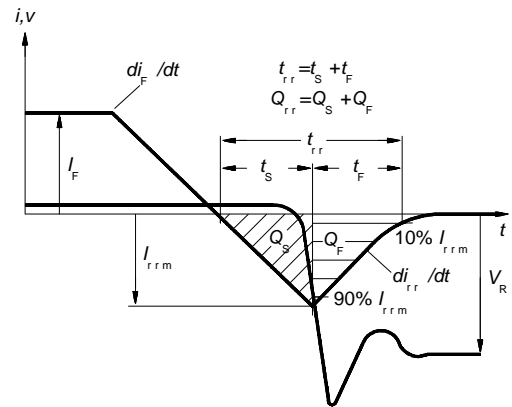
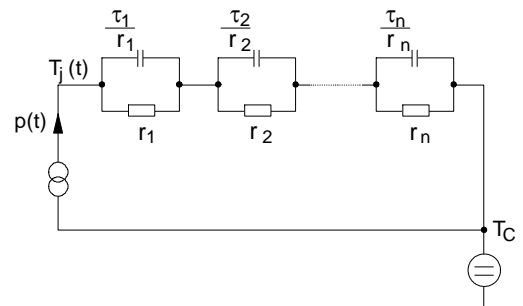
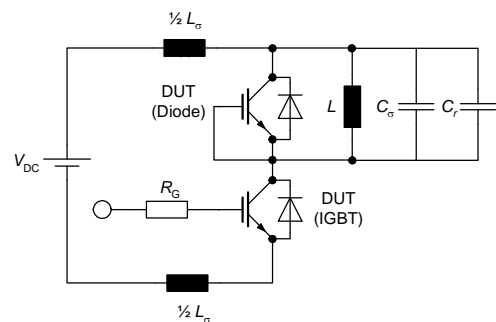
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**Figure A. Definition of switching times**

**Figure B. Definition of switching losses**

**Figure C. Definition of diodes switching characteristics**

**Figure D. Thermal equivalent circuit**

**Figure E. Dynamic test circuit**  
 Leakage inductance  $L_\sigma = 180\text{nH}$ ,  
 Stray capacitor  $C_\sigma = 40\text{pF}$ ,  
 Relief capacitor  $C_r = 4\text{nF}$  (only for ZVT switching)

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